



IC Packages, Assembly & Prototype Services

Press Release

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Quik-Pak Announces ITAR Registration

San Diego, CA, August 25, 2009, - Quik-Pak, a division of Delphon Industries and leader in quick-turn integrated circuit (IC) prototype packaging, wafer processing, and advanced assembly services announced today that they have received their official International Traffic in Arms Regulations (ITAR) registration from the US Department of State, Bureau of Political-Military Affairs.

This registration documents Quik-Pak's dedication to adhering to the strict regulations that control the export and import of defense-related articles and services. Quik-Pak is working to meet all ITAR compliance requirements in their organizational structure, documentation, training, quality systems, technology control plans and procedures. A commitment to ITAR compliance ensures that Quik-Pak has the knowledge, ability and regulatory oversight to properly meet the unique needs of the Defense

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industry.

About Quik-Pak:

The company specializes in open-cavity plastic packages and assembly in 24 hours or less. A limitless array of open-cavity packages are available with no minimum quantity and can be provided as part of a turnkey assembly solution along with backgrinding, wafer dicing, die/wire bonding, laser micromachining, detector array processing, remolding and marking/branding. Custom assembly services are also offered for ceramic packages, chip-on-board, stacked die, MEMS, etc. Quik-Pak's unique offerings deliver faster time to market and reduced prototype costs for new devices, while providing excellent flexibility, quality and customer service.

For further information:

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